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RECORDATION FORM COVER
PATENTS ONLY



103543326

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies):

Jung Goo Park

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): December 17, 2008

- ☒ Assignment ☐ Merger ☐ Change of Name
☐ Security Agreement ☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

2. Name and address of receiving party(ies)

Name: MagnaChip Semiconductor, Ltd.

Internal Address:

Street Address:

1 Hyangjeong-dong, Heungduk-gu,

City: Cheongju-Si

State: Chungcheongbuk-do

Country: Republic of Korea Zip: 361-725

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Collin W. Park
MORGAN LEWIS & BOCKIUS LLP

Internal Address: Atty. Dkt.: 064991-5031US
Street Address: 1111 Pennsylvania Ave NW

City: Washington

State: DC Zip: 20004

Phone Number: (202) 739-3000

Fax Number: (202) 739-3001

Email Address: patents@morganlewis.com

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☒ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

Deposit Account Number 50-0310

Authorized User Name Collin W. Park

9. Signature:

Collin W. Park

Signature

December 29, 2008

Date

Collin W. Park - 43,378

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

2

01/12/2009 MJAMA1 00000047 500310 12318392

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ATTORNEY DOCKET NO.:
SOLE/JOINT INVENTION
(U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

Method for forming gate oxide of semiconductor device

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. _____); and

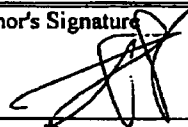
WHEREAS, Magnachip Semiconductor, LTD., a corporation of Republic Korea, whose post office address is 1, Hyangjeong-dong, Heungdeok-gu, Cheongju-si, Chungbuk, 361-728, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed December 29, 2008 the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor PARK, Jung Goo	Assignor's Signature 	Date Dec. 17, 2006
Address Rm No. 301, Jinjuvil, 78-13, Yonggye-dong, Dong-gu, Daejeon, 300-450, Republic of Korea		Citizenship Republic of Korea
Full Name of Second Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		